



# Step Recovery Diode Doubler

## INTRODUCTION

A straightforward technique for multiplier design is presented. The input circuit is a low pass filter which allows all of the input power to be absorbed by the diode and reflects harmonic power back to the diode. The output circuit is a bandpass filter which offers a low loss path to the desired frequency while reflecting all other harmonics back to the diode.

## FREQUENCY MULTIPLICATION WITH STEP RECOVERY DIODES

A step recovery diode has two operating states. With forward bias it looks like a large capacitor — a low impedance. Under reverse bias it looks like a small capacitor — a high impedance. However, the diode is a three layer device and charge can be injected and stored in one of these layers, the I (intrinsic) layer, when forward bias is applied. The change from low impedance to high impedance does not take place until reverse current flows long enough to remove the charge. The change then takes place quickly, in a time interval called the diode transition time.

This sudden change in diode resistance causes a sudden change in current through the final inductor of the low pass filter. This produces a narrow pulse of voltage which is equivalent to a number of frequencies which are multiples of the input frequency. The highest multiple is limited by the narrowness of the pulse which is determined by the transition time. The multiplier is completed by adding a bandpass filter to pass the desired multiple and reflect all others. By properly spacing the multiplier from the filter, much of the power in these unwanted frequencies can be converted to the desired output<sup>[1]</sup>.

## BIAS CURRENT

For maximum efficiency the sudden change of diode resistance should occur at the negative peak of the input waveform. This is controlled by providing negative DC bias to the diode to set the time when conduction starts during the position portion of the input wave. This bias voltage may be provided by a resistor across the input circuit. Rectified current from the diode flows through the bias resistor to generate the negative bias voltage. The proper value of bias resistance is<sup>[2]</sup>

$$R_B = \frac{2\tau}{\pi N^2 C}$$

where  $\tau$  is the lifetime,  $100 \times 10^{-9}$  seconds,  $N$  is the multiplication factor, and  $C$  is the diode capacitance, 3 pF, so that  $R_B = 5300$  ohms.

The major effect of temperature on step recovery diodes is an increase of lifetime of  $0.5\%/^{\circ}\text{C}$ . This is easily compensated by using a silicon resistor, a sensistor, for the bias resistor. Sensistors with this temperature sensitivity are available.

## DIODE CHOICE

The design technique will be illustrated by a doubler from 2 to 4 GHz. In the Hewlett-Packard Diode Designer's Catalog the 5082-0805 Step Recovery Diode is recommended for a 4 GHz output frequency. This fits the multiplier rule that the transition time should be equal to or less than the inverse of the output frequency. In this case the typical transition time is 250 picoseconds, the inverse of the 4 GHz output frequency.

A similar rule relates input frequency to lifetime. The lifetime should exceed the inverse of the input frequency. Since the lifetime always exceeds the transition time by a factor of several hundred, this lifetime limitation is not important for low order multipliers.

In some multiplier applications, the breakdown voltage limits the output power. However, for a CW doubler to 4 GHz, the thermal resistance,  $\theta_{jc}$ , is the limiting factor.

$$P_{MAX} = \frac{200 - T}{\theta_{jc}}$$

For an ambient temperature,  $T$ , of  $25^{\circ}\text{C}$ , and  $\theta_{jc} = 20^{\circ}\text{C/W}$ ,  $P_{MAX} = 8.8$  watts. In pulse applications, where the thermal resistance is not the limiting factor, the breakdown voltage limits the power output<sup>[3]</sup>.

$$P_{MAX} = 0.4 I_{OUT} C_j V_B^2$$

For a 3 pF junction capacitance, 4 GHz output frequency, and 75 volts breakdown, power output is limited to 27 watts.

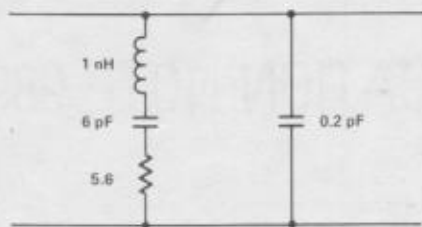


Figure 1. Diode Equivalent Circuit

### DIODE EQUIVALENT CIRCUIT

The diode chip is represented by a capacitor in series with a resistor<sup>[4]</sup>. The capacitance is double the value measured at 1 MHz with reverse voltage. In this case,  $2 \times 3 \text{ pF} = 6 \text{ pF}$ . The resistance is computed from the input frequency  $\omega_{in}$  and the reverse bias junction capacitance  $C_{min}$  with the formula

$$\frac{0.21}{\omega_{in} C_{min}} = 5.6 \text{ ohms}$$

The rest of the diode circuit includes 1 nH package inductance and 0.2 pF package capacitance as shown in Figure 1.

### INPUT FILTER

The initial design of the input filter is based on a low pass impedance transforming network using a lumped element prototype<sup>[5]</sup> shown in Figure 2. The diode impedance at 2 GHz is  $5.61 - j 0.77$ . The prototype is normalized to unity generator impedance so the load conductance  $g_5$  is

$$r = \frac{50}{5.6} = 8.9$$

The series element  $g_4$  will be modified later to include the load reactance.

The number of filter elements is determined by the impedance transformation ratio  $r$  (8.9), the bandwidth, and the desired passband ripple.

A bandwidth from 1.9 GHz to 2.1 GHz was chosen with a ripple less than 0.04 dB (SWR = 1.2). Table 2 in the Matthaei article shows that a four element filter as shown in Figure 2 will easily satisfy these requirements. Table 7 provides  $g_1 = 1.54$  and  $g_2 = 0.61$ . The other elements are  $g_3 = g_2$ ,  $r = 5.4$  and

$$g_4 = \frac{g_1}{r} = 0.17$$

This prototype assumes a center angular frequency of unity as well as a one ohm generator. Normalization is removed by changing generator and load to 50 ohms and 5.6 ohms, dividing  $g_1$  and  $g_3$  by 50, multiplying  $g_2$  and  $g_4$  by 50 and dividing all elements by the center frequency  $\omega = 2\pi \times 2 \times 10^9$ . The lumped element filter now consists of:

$$C_1 = \frac{g_1}{50\omega} = 2.45 \text{ pF} \quad C_3 = \frac{g_3}{50\omega} = 8.6 \text{ pF}$$

$$L_2 = \frac{50 g_2}{\omega} = 2.43 \text{ nH} \quad L_4 = \frac{50 g_4}{\omega} = 0.68 \text{ nH}$$

Since the diode impedance at 2 GHz is  $5.61 - j 0.77$ , the value of  $L_4$  must be increased by 0.06 nH to cancel the diode reactance.

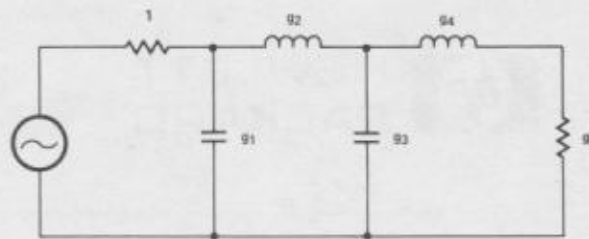


Figure 2. Low Pass Prototype for Input Filter

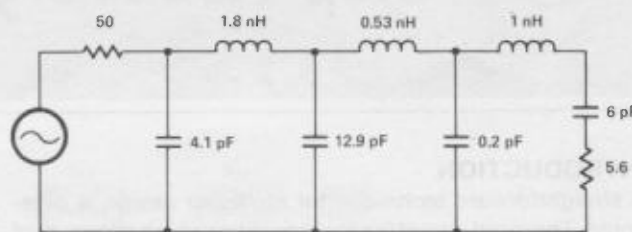


Figure 3. Optimized Lumped Element Low Pass Filter

When this modified filter is used with the diode equivalent circuit of Figure 1 the maximum SWR is 1.3 because the modification of  $L_4$  is valid only at the center frequency. Figure 3 shows the filter optimized by the Compact<sup>[6]</sup> computer program to reduce the maximum SWR to 1.09.

### LUMPED ELEMENTS TO SERIES TRANSMISSION LINES

It is often possible to transform lumped elements to equivalent series transmission lines which are easier to realize in microstrip circuits. However, the validity of this substitution depends on the size of the load impedance and the size of the lumped element.

Consider the possibility of substituting a length,  $\theta$ , of transmission line of characteristic impedance  $Z_0$  for a series inductance  $L$  which is followed by a load impedance  $Z_L$ . This is valid when

$$Z_0 \frac{Z_L + jZ_0 \tan \theta}{Z_0 + jZ_L \tan \theta} = Z_L + j\omega L$$

If  $Z_L \tan \theta \ll Z_0$  and  $\theta$  is small so that  $\tan \theta = \theta = \frac{\omega \ell}{\nu}$ , then this expression simplifies to

$$Z_0 \frac{\omega \ell}{\nu} = \omega L$$

$$\ell = \frac{L\nu}{Z_0}$$

where  $\omega$  = angular frequency  
 $\ell$  = length of transmission line  
 and  $\nu$  = velocity of propagation

The requirement that  $\tan \theta = \theta$  assures that the substitution is valid over a range of frequencies. This means that the transmission line must be short,  $\theta$  less than 0.5 radian. The other equation limits the size of the load impedance.

$$Z_L \theta \ll Z_0$$

If we accept 80 ohms as the largest reasonable characteristic impedance, then  $Z_L \theta$  should be no more than 8 ohms so that  $Z_L \theta \ll 80$ . In the worst case  $\theta = 0.5$ ,  $Z_L$  should be less than 16 ohms.

Consider  $L_4 = 0.53$  nH terminated with the diode impedance  $5.6 - j 0.8$ . Since the load impedance is small we can replace  $L_4$  with an 80 ohm microstrip line with length in alumina

$$(\nu = \frac{c}{\sqrt{\epsilon}} = \frac{30}{2.45} \text{ cm/ns})$$

$$\ell = \frac{L\nu}{Z_0} = \frac{0.53 \times 30}{80 \times 2.45} = 0.081 \text{ cm (.032 inch)}$$

or 4.8 degrees.

Similarly the load seen by  $L_2$  is small so  $L_2$  can be replaced by an 80 ohm line of length

$$\frac{1.8 \times 30}{80 \times 2.45} = 0.28 \text{ cm (0.11 inch)}$$

or 16.1 degrees.

Similar analysis of the shunt elements leads to the requirement

$$Y_L \ll Y_0/\theta$$

The admittance of the diode plus  $L_4$  is  $0.085 - j 0.089$  at 2 GHz. The largest reasonable value of  $Y_0$ , corresponding to 20 ohms characteristic impedance, is 0.05 so this condition is not satisfied unless the line length is extremely short, about  $3^\circ$ .

The equivalent line requires  $1000 Y_0 \ell = C\nu$ . For  $C = 12.9$  pF

$$\ell = \frac{12.9 \times 30 \times 20}{1000 \times 2.75} = 2.81 \text{ cm}$$

or 3.2 radians. This is much longer than 0.5 radian so a series length of line is not a good approximation for this shunt capacitor.

### OPEN LINES FOR CAPACITORS

Each shunt capacitor may be represented by a pair of shunt open lines with the relationship

$$Y_0 \tan \theta = \frac{\omega C}{2}$$

Use a large  $Y_0$ , 0.05, to keep  $\theta$  as small as possible. For  $C = 12.9$  pF

$$\tan \theta = \frac{20 \times 4 \pi \times 12.2}{2000} = 1.62$$

$$\theta = 58.3^\circ$$

For  $C = 4.1$  pF,  $\theta = 27.3^\circ$ .

Replacing lumped elements with distributed elements has little effect on maximum SWR. Optimization of the open lengths results in less than 10% change and a maximum SWR of 1.09.

### EFFECT OF INPUT FILTER ON DESIGN OF OUTPUT FILTER

Before proceeding with the output filter design, we should compute the effect of this low pass filter on the diode impedance at the output frequency.

At 4 GHz the input filter from the diode looks like  $0.66$  nH. This changes the diode impedance from  $6.8 + j20$  to  $1.4 +$

$j9.8$ . An unsuccessful attempt was made to modify the filter elements to provide an open circuit at 4 GHz while maintaining a match to the diode at the input frequency band. However, this was successfully accomplished by adding shunt open lines at the diode to resonate the filter at 4 GHz. These lines are  $30^\circ$  long at 4 GHz with 20 ohm characteristic impedance. The effect at the input frequency is small. Maximum SWR for 1900 MHz to 2100 MHz goes up from 1.09 to 1.10.

### OUTPUT FILTER DESIGN

A parallel coupled line filter is used at the output. In order to have a symmetrical filter the generator impedance is first changed to 50 ohms. The 20.6 ohm reactance is resonated with a 2 pF series capacitor. Then the 6.8 ohm generator is transformed to 50 ohms with a quarter wave line of 18.5 ohm characteristic impedance.

The number of filter elements is determined by the requirement that the filter attenuation be high at the input frequency. For  $n = 3$  the isolation at 2 GHz is 37 dB. For  $n = 2$  isolation is under 20 dB<sup>[7]</sup>.

For  $n = 3$  the prototype element values for a Chebyshev filter with 0.01 dB ripple are  $g_1 = 0.629$ ,  $g_2 = 0.970$ ,  $g_3 = g_1$ ,  $g_4 = 1 = g_0$ <sup>[8]</sup>. For our normalized bandwidth of

$$\frac{4200-3800}{4000} = 0.1$$

these element values transform to the following impedance values<sup>[9]</sup> for a parallel coupled line filter operating between 50 ohm source and load.

$$\begin{aligned} (Z_{oe})_{01} &= (Z_{oe})_{34} = 87.5 \text{ ohms} \\ (Z_{oo})_{01} &= (Z_{oo})_{34} = 37.5 \text{ ohms} \\ (Z_{oe})_{12} &= (Z_{oe})_{23} = 62 \text{ ohms} \\ (Z_{oo})_{12} &= (Z_{oo})_{23} = 42 \text{ ohms} \end{aligned}$$

From this data the width ( $W$ ) and separation ( $S$ ) of the coupled line filter can be computed<sup>[10]</sup>.

$$\begin{aligned} W_{01} &= W_{34} = 14 \text{ mils} \\ S_{01} &= S_{24} = 4.8 \text{ mils} \\ W_{12} &= W_{23} = 22.5 \text{ mils} \\ W_{12} &= S_{23} = 16 \text{ mils} \end{aligned}$$

When analyzed between 50 ohm generator and load, maximum SWR is 1.04. However, when the load is the resonated diode, the maximum SWR rises to 1.9. Optimizing the circuit elements reduces this maximum SWR to 1.6.

Since the load for the input and output filters is not simply the diode but includes the other filter behind the diode, the reflection coefficient doubles at some frequencies. Maximum input SWR over the 10% band is 1.17. Maximum output SWR is 2.92. Figure 4 shows the computer output for the complete multiplier.

Figure 5 is a sketch of the multiplier on 0.025 inch alumina microstrip.

### CONCLUSION

Multiplier design techniques have been illustrated by a doubler to 4 GHz using Hewlett-Packard 5082-0805 step recovery diode. Using similar techniques a doubler with power output of 4 watts has been reported<sup>[11]</sup>. Bandwidth exceeded 10%. The procedure for higher order multipliers is similar, but the formula for equivalent diode resistance uses different constants<sup>[4]</sup>.

COMPACT						
COMMAND FILE ==> MULT						
OST	AA	PA	20.00	-27.1	2000.	
CAS	AA	AA				
TRL	BB	SE	80.00	-15.10	2000.	
OST	CC	PA	20.00	-58.1	2000.	
CAS	CC	CC				
TRL	DD	SE	80.00	- 4.6	2000.	
OST	EE	PA	20.00	-30.	4000.	
CAS	EE	EE				
CAP	FF	PA	.2000			
SRX	GG	PA	5.630	1.000	6.000	
CAP	HH	SE	2.000			
TRL	II	SE	-21.6	90.00	4000.	
CPL	KK	MS	-10.5	- 2.9	289.0	9.600 25.00
CPL	LL	MS	-21.4	- 8.1	289.0	9.600 25.00
CON	KK	T4	1.000	2.000	3.000	4.000
CON	LL	T4	3.000	5.000	6.000	7.000
CON	LL	T4	6.000	8.000	9.000	10.000
CON	KK	T4	9.000	11.00	12.000	13.00
DEF	JJ	T2	1.000	12.00		
CAX	AA	JJ				
PRI	AA	S1	50.00			
END						
1800	2200	50				
3600	4400	100				
END						

FREQUENCY	S <sub>11</sub>	S <sub>21</sub>	S <sub>12</sub>	S <sub>22</sub>	
1800.00	.23<- 49	.00<- 94.5	.001<- 97.4	1.00<- 78	-63.54
1850.00	.14<- 25	.00<-101.4	.001<- 84.1	1.00<- 81	-62.70
1900.00	.08<- 13	.00<-107.8	.001<-107.8	1.00<- 84	-61.83
1950.00	.07<- 63	.00<-113.8	.001<-107.1	1.00<- 87	-60.87
2000.00	.06<- 96	.00<-119.8	.001<-119.8	1.00<- 90	-59.78
2050.00	.04<-103	.00<-126.3	.001<-126.3	1.00<- 94	-58.51
2100.00	.04<- 28	.00<-134.0	.001<-137.5	1.00<- 97	-57.10
2150.00	.13<- 10	.00<-143.3	.002<-146.9	1.00<-100	-55.60
2200.00	.28<- 20	.00<-154.9	.002<-154.0	1.00<-104	-54.17
3600.00	1.00<-155	.02<- 9.0	.020<- 9.0	.91<- 16	-33.94
3700.00	1.00<-157	.04<- 49.4	.036<- 49.4	.74<- 48	-28.87
3800.00	1.00<-158	.05<-101.0	.052<-101.0	.42<-140	-25.72
3900.00	1.00<-160	.06<-150.0	.058<-150.0	.23<- 102	-24.74
4000.00	1.00<-161	.06<- 166.5	.061<- 166.5	.14<- 15	-24.35
4100.00	1.00<-162	.06<- 122.5	.061<- 122.5	.18<-179	-24.24
4200.00	1.00<-163	.06<- 77.2	.055<- 77.2	.49<- 87	-25.18
4300.00	1.00<-164	.04<- 37.3	.043<- 37.3	.74<- 24	-27.42
4400.00	1.00<-165	.03<- 6.8	.031<- 6.8	.87<- 23	-30.04

Figure 4. Computer Analysis of Multiplier

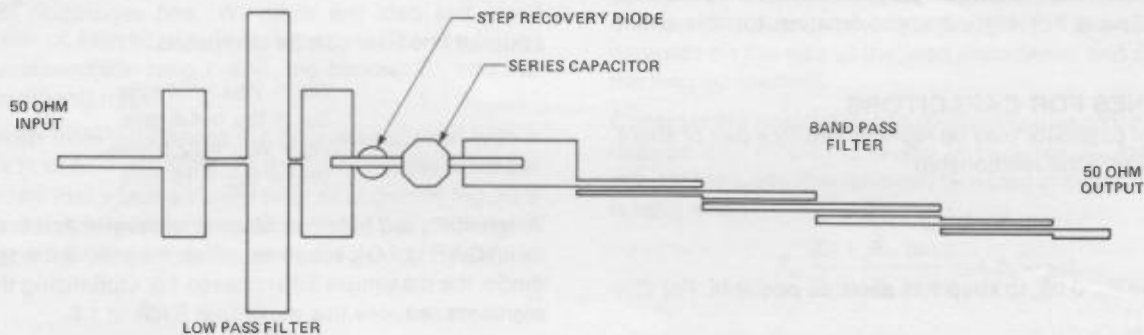


Figure 5. Microstrip Doubler

## REFERENCES

- Hewlett-Packard Application Note 983, "Comb Generator Simplifies Multiplier Design".
- S. Hamilton and R. Hall, "Shunt Mode Harmonic Generation Using Step Recovery Diodes", *Microwave Journal*, April 1967, p.77.
- R. M. Scarlett, "Harmonic Generation with a Capacitor Exhibiting an Abrupt Capacitance Change", *Proc. I.E.E.E.*, May, 1964, pp. 612-613.
- C. B. Burkhardt, "Analysis of Varactor Frequency Multipliers for Arbitrary Capacitance Variation and Drive Level", *Bell System Technical Journal*, pp. 675-692, April, 1965.
- G. L. Matthaei, "Table of Chebyshev Impedance — Transforming Networks of Low Pass Filter Form", *Proc. I.E.E.E.*, vol. 52, no. 8, pp. 930-963, August, 1964.
- Compact Division of CGIS, Palo Alto, CA 94303.
- G. Matthaei, L. Young, and E. Jones, "Microwave Filters, Impedance — Matching Networks, and Coupling Structures", McGraw-Hill Book Company, 1964, p.89.
- ibid, p. 100
- ibid, p. 473
- Gunston, M.A.R. "Microwave Transmission-Line Impedance Data" Van Nostrand Reinhold Company, London, 1972.
- Faysal H. Ghouil, Les Besser, and Chi Hsieh, "Design a High Power S-Band Doubler". *Microwaves*, June, 1974, pp. 58-65.

Hewlett-Packard assumes no responsibility for the use of any circuits described herein and makes no representations or warranties, express or implied, that such circuits are free from patent infringement.

For more information call your local HP Sales Office or East (301) 948-6370 — Midwest (312) 255-9800 — South (404) 955-1500 — West (213) 970-7500. Or write: Hewlett-Packard Components, 350 West Trimble Road, San Jose, California 95131. In Europe, Hewlett-Packard GmbH, P.O. Box 250, Herrenberger Str. 110, D-7030 Boeblingen, West Germany. In Japan, YHP, 3-29-21, Takaido-Higashi, Suginami Ku, Tokyo 168.